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PATENT
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re application of: Chun Ho FAN et al. Divisional Application of Parent Serial No.10/166,458 Serial No.: Currently unknown Filing Date: Concurrently herewith For: MULTIPLE LEADFRAME LAMINATED IC PACKAGE | |
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PRELIMINARY AMENDMENT

Mail Stop PATENT APPLICATION
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to examination on the merits, please amend the above-identified patent application as follows:

- Amendments to the Specification** begin on page 2 of this paper.
- Amendments to the Claims** are reflected in the listing of the claims

which begins on page 3 of this paper.

Amendments to the Drawings begin on page _____ of this paper and include an attached replacement sheet.

- Remarks/Arguments** begin on page 5 of this paper

Please note, if a box is not checked, then no corresponding amendment is being made.